Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

Except below description page
 "Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan

Doc No. TT4-EA-12652

Revision. 2

Panasonic _____

MOS FET

FC6946010R

FC6946010R

Dual N-channel MOS FET

For switching

Features

Low drive voltage: 2.5 V driveHalogen-free / RoHS compliant

(EU RoHS / UL-94 V-0 / MSL : Level 1 compliant)

■ Marking Symbol : V6

Established: 2010-06-25

: 2013-07-04

Revised

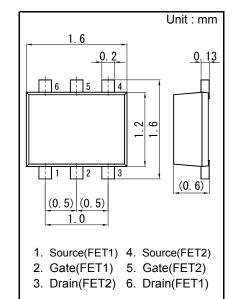
■ Basic Part Number : Dual FK390601 (Individual)

■ Packaging

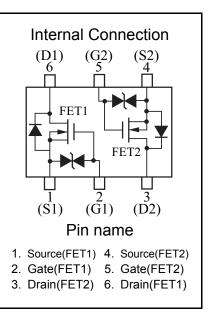
Embossed type (Thermo-compression sealing): 8 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter		Symbol	Rating	Unit	
	Drain-source breakdown voltage	VDSS	60	V	
	Gate-source breakdown voltage	VGSS	±12	V	
FET2	Drain current	ID	100	mA	
	Pulse drain current	IDp	200	mA	
Overall	Total power dissipation	PT	125	mW	
	Channel temperature	Tch	150	°C	
	Operating ambient temperature	Topr	-40 to +85	°C	
	Storage temperature	Tstg	-55 to +150	°C	



Panasonic	SSMini6-F3-B		
ILITA	00.4070		
JEITA	SC-107C		
Code	SOT-666		
Code	301-000		



Doc No. TT4-EA-12652 Revision. 2

Panasonic

MOS FET

Page 2 of 6

FC6946010R

■ Electrical Characteristics Ta = 25 °C ± 3 °C FET1,FET2

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source breakdown voltage	VDSS	ID = 1 mA, VGS = 0	60			V
Drain-source cutoff current	IDSS	VDS = 60 V, VGS = 0			1.0	μΑ
Gate-source cutoff current	IGSS	VGS = ±10 V, VDS = 0			±10	μΑ
Gate threshold voltage	VTH	ID = 1.0 μA, VDS = 3.0 V	0.9	1.2	1.5	V
Drain-source ON resistance	RDS(on)1	ID = 10 mA, VGS = 2.5 V		8	15	Ω
Dialii-source Oiv resistance	RDS(on)2	ID = 10 mA, VGS = 4.0 V		6	12	Ω
Forward transfer admittance	Yfs	ID = 10 mA, VDS = 3.0 V	20	60		mS
Input capacitance	Ciss			12		pF
Output capacitance	Coss	VDS = 3 V, VGS = 0, f = 1 MHz		7		pF
Reverse transfer capacitance	Crss			3		pF
Turn-on time *1	ton	VDD = 3 V, VGS = 0 to 3 V		100		ns
rum-on ume	ton	ID = 10 mA				
Turn-off time *1	toff	VDD = 3 V, VGS = 3 to 0 V		100		ns
rum-on ume	ton	ID = 10 mA				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

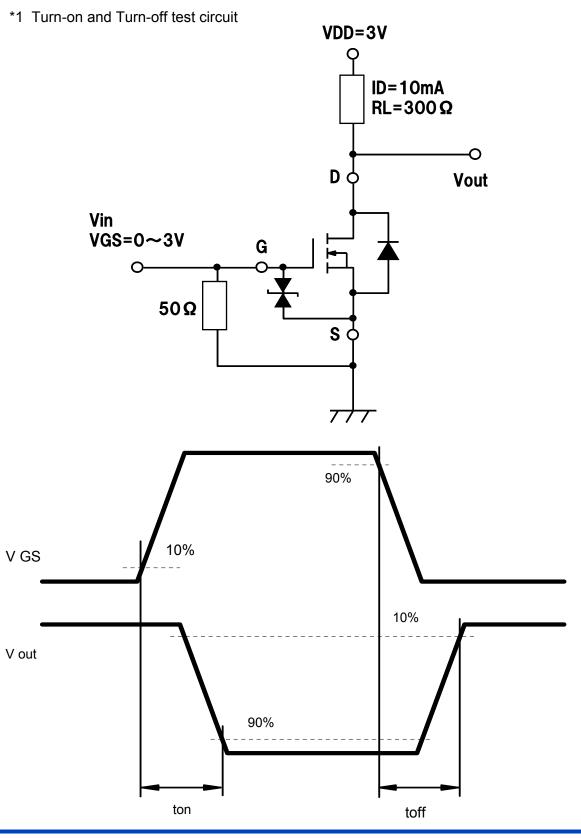
Established: 2010-06-25

Revised

: 2013-07-04

^{2. *1} Turn-on and Turn-off test circuit

Panasonic



Page 3 of 6

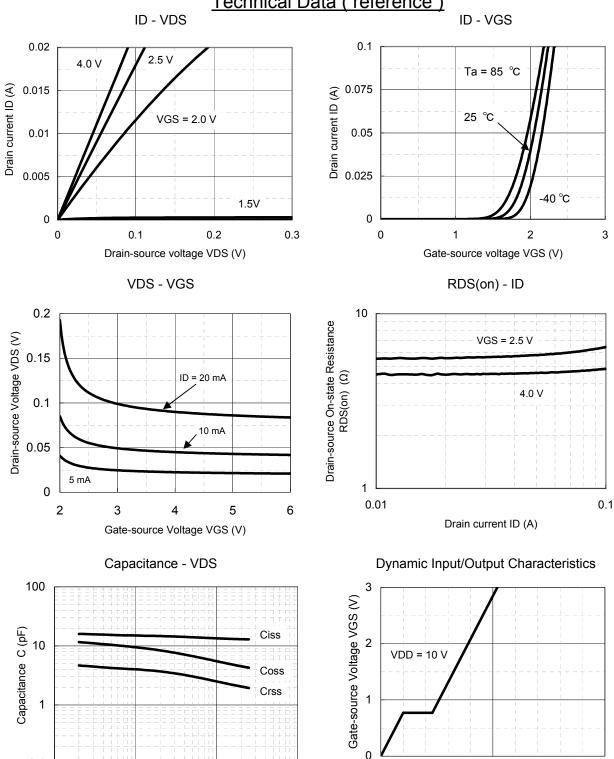
Established: 2010-06-25 Revised: 2013-07-04

MOS FET

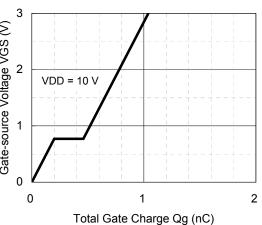
FC6946010R

Panasonic





0.1 0.1 10 100 Drain-source Voltage VDS (V)



Page 4 of 6

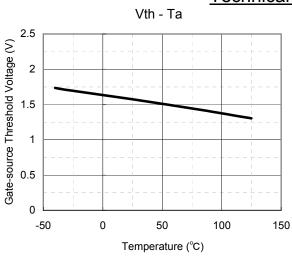
Established: 2010-06-25

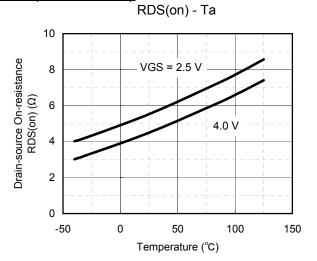
Panasonic

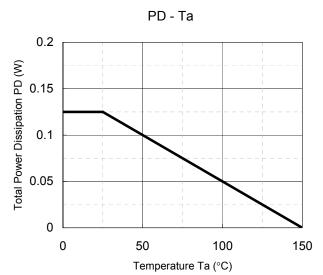
MOS FET

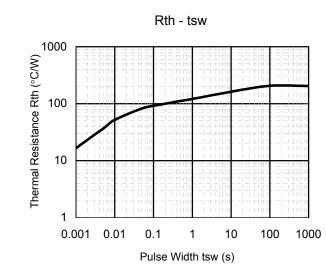
FC6946010R

Technical Data (reference)









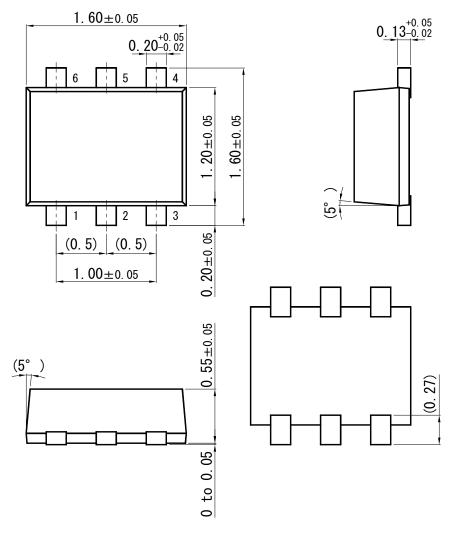
Established: 2010-06-25 Revised: 2013-07-04 **Panasonic**

MOS FET

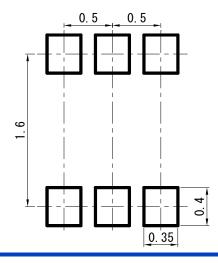
FC6946010R

SSMini6-F3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



Page 6 of 6

Established: 2010-06-25 Revised: 2013-07-04

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